

TPS54233EVM-373 2-A, SWIFT™ Regulator Evaluation Module

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1 Introduction

This user's guide contains background information for the TPS54233 as well as support documentation for the TPS54233EVM-373 evaluation module (HPA373). Also included are the performance specifications, the schematic, and the bill of materials for the TPS54233EVM-373.

1.1 Background

The TPS54233 dc/dc converter is designed to provide up to a 2 A output from an input voltage source of 3.5 V to 28 V. Rated input voltage and output current range for the evaluation module are given in [Table 1](#). This evaluation module is designed to demonstrate the small printed-circuit-board areas that may be achieved when designing with the TPS54233 regulator. The switching frequency is internally set at a nominal 300 kHz. The high-side MOSFET is incorporated inside the TPS54233 package along with the gate drive circuitry. The low drain-to-source on resistance of the MOSFET allows the TPS54233 to achieve high efficiencies and helps keep the junction temperature low at high output currents. The compensation components are external to the integrated circuit (IC), and an external divider allows for an adjustable output voltage. Additionally, the TPS54233 provides adjustable slow start and undervoltage lockout inputs. The absolute maximum input voltage is 30 V for the TPS54233EVM-373.

Table 1. Input Voltage and Output Current Summary

EVM	INPUT VOLTAGE RANGE	OUTPUT CURRENT RANGE
TPS54233EVM-373	$V_{IN} = 8\text{ V to }18\text{ V}$	0 A to 2 A

1.2 Performance Specification Summary

A summary of the TPS54233EVM-373 performance specifications is provided in [Table 2](#). Specifications are given for an input voltage of $V_{IN} = 15\text{ V}$ and an output voltage of 3.3 V, unless otherwise specified. The TPS54233EVM-373 is designed and tested for $V_{IN} = 7\text{ V to }28\text{ V}$. The ambient temperature is 25°C for all measurements, unless otherwise noted.

Table 2. TPS54233EVM-373 and Performance Specification Summary

SPECIFICATION	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{IN} voltage range		7	15	18	V
Output voltage set point			3.3		V
Output current range	$V_{IN} = 8\text{ V to }18\text{ V}$	0		2	A
Line regulation	$I_O = 1\text{ A}, V_{IN} = 8\text{ V to }18\text{ V}$	±0.025%			
Load regulation	$V_{IN} = 15\text{ V}, I_O = 0\text{ A to }2\text{ A}$	±0.03%			
Load transient response	$I_O = 0.5\text{ A to }1.5\text{ A}$	Voltage change		-20	mV
		Recovery time		400	µs
	$I_O = 1.5\text{ A to }0.5\text{ A}$	Voltage change		20	mV
		Recovery time		400	µs
Loop bandwidth	$V_{IN} = 15\text{ V}, I_O = 1\text{ A}$	9.0			kHz
Phase margin	$V_{IN} = 15\text{ V}, I_O = 1\text{ A}$	70			°
Input ripple voltage	$I_O = 2\text{ A}$	250			mVpp
Output ripple voltage	$I_O = 2\text{ A}$	70			mVpp
Output rise time		3.5			ms
Operating frequency		300			kHz
Maximum efficiency	TPS54233EVM-373, $V_{IN} = 8\text{ V}, I_O = 0.4\text{ A}$	91.2%			

1.3 Modifications

These evaluation modules are designed to provide access to the features of the TPS54233. Some modifications can be made to this module.

1.3.1 Output Voltage Set Point

To change the output voltage of the EVM, it is necessary to change the value of resistor R_6 . Changing the value of R_6 can change the output voltage above 0.8 V. The value of R_6 for a specific output voltage can be calculated using [Equation 1](#).

$$R_6 = 10.2 \text{ k}\Omega \times \frac{0.8 \text{ V}}{V_{\text{Out}} - 0.8 \text{ V}} \quad (1)$$

[Table 3](#) lists the R_6 values for some common output voltages. Note that V_{IN} must be in a range so that the minimum on-time is greater than 160 ns, and the maximum duty cycle is less than 90%. The values given in [Table 3](#) are standard values, not the exact value calculated using [Equation 1](#).

Table 3. Output Voltages Available

Output Voltage (V)	R_6 Value (k Ω)
1.8	8.25
2.5	4.75
3.3	3.24
5	1.96

2 Test Setup and Results

This section describes how to properly connect, set up, and use the TPS54233EVM-373 evaluation module. The section also includes test results typical for the evaluation module and covers efficiency, output voltage regulation, load transients, loop response, output ripple, input ripple, and start-up.

2.1 Input / Output Connections

The TPS54233EVM-373 is provided with input/output connectors and test points as shown in [Table 4](#). A power supply capable of supplying 2 A must be connected to J1 through a pair of 20 AWG wires. The load must be connected to J4 through a pair of 20 AWG wires. The maximum load current capability must be 2 A. Wire lengths must be minimized to reduce losses in the wires. Test-point TP1 provides a place to monitor the V_{IN} input voltages with TP2 providing a convenient ground reference. TP5 is used to monitor the output voltage with TP6 as the ground reference.

Table 4. EVM Connectors and Test Points

Reference Designator	Function
J1	V_{IN} (see Table 1 for V_{IN} range)
J2	2-pin header for enable. Connect EN to ground to disable, open to enable.
J3	2-pin header for slow start monitor and GND.
J4	V_{OUT} , 3.3 V at 2 A maximum
TP1	V_{IN} test point at V_{IN} connector
TP2	GND test point at V_{IN}
TP3	PH test point
TP4	Test point between voltage divider network and output. Used for loop response measurements.
TP5	Output voltage test point at OUT connector
TP6	GND test point at OUT connector

2.2 Efficiency

The efficiency of this EVM peaks at a load current of about 0.5 A - 1 A and then decreases as the load current increases towards full load. Figure 1 shows the efficiency for the TPS54233EVM-373 at an ambient temperature of 25°C.

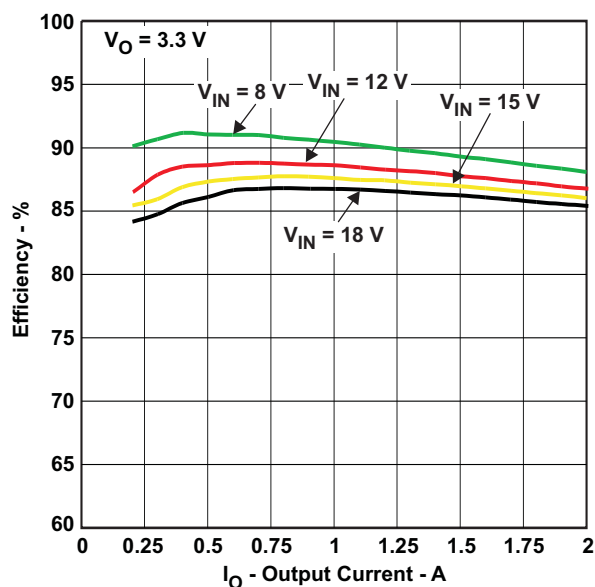

Figure 1. TPS54233EVM-373 Efficiency

Figure 2 shows the efficiency for the TPS54233EVM-373 at lower output currents between 0.01 A and 0.20 A at an ambient temperature of 25°C.

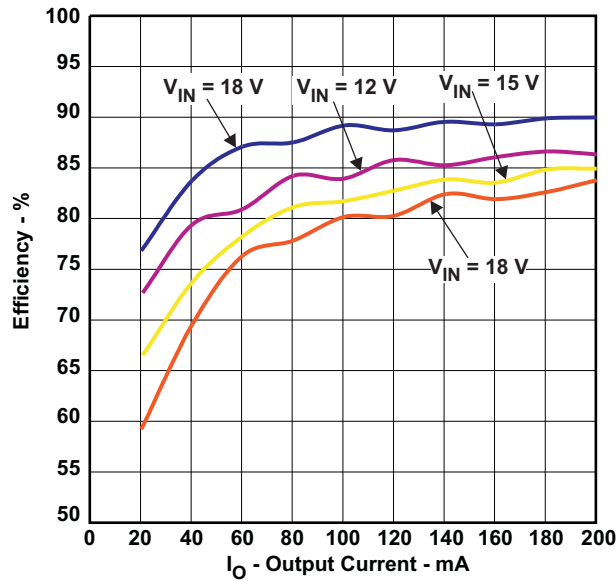


Figure 2. TPS54233EVM-373 Low Current Efficiency

The efficiency may be lower at higher ambient temperatures, due to temperature variation in the drain-to-source resistance of the internal MOSFET.

2.3 Output Voltage Load Regulation

The load regulation for the TPS54233EVM-373 is shown in Figure 3.

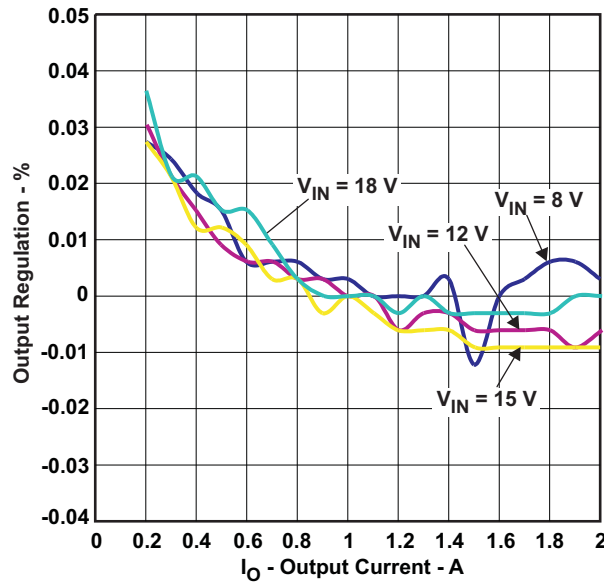


Figure 3. TPS54233EVM-373 Load Regulation

Measurements are given for an ambient temperature of 25°C.

2.4 Output Voltage Line Regulation

The line regulation for the TPS54233EVM-373 is shown in Figure 4.

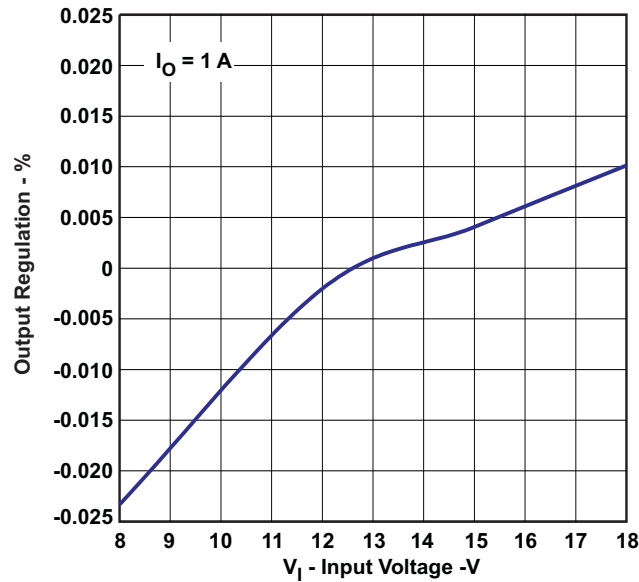


Figure 4. TPS54233EVM-373 Line Regulation

2.5 Load Transients

The TPS54233EVM-373 response to load transients is shown in Figure 5. The current step is from 25% to 75% of maximum rated load. Total peak-to-peak voltage variation is as shown, including ripple and noise on the output.

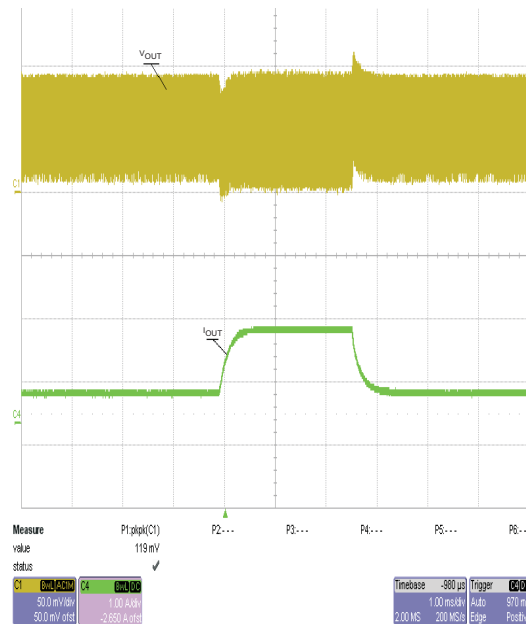


Figure 5. TPS54233EVM-373 Transient Response

2.6 Loop Characteristics

The TPS54233EVM-373 loop-response characteristics are shown in Figure 6 . Gain and phase plots are shown for V_{IN} voltage of 15 V. Load current for the measurement is 1 A.

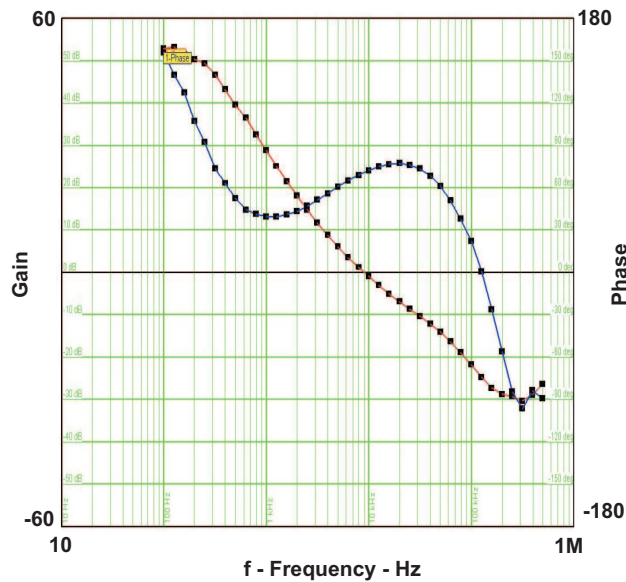


Figure 6. TPS54233EVM-373 Loop Response

2.7 Output Voltage Ripple

The TPS54233EVM-373 output voltage ripple is shown in Figure 7 . The output current is the rated full load of 2 A. Voltage is measured directly across the output capacitors.

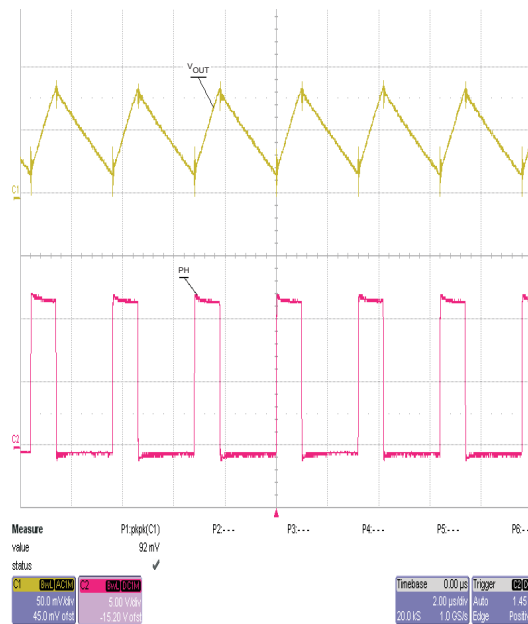


Figure 7. TPS54233EVM-373 Output Ripple

2.8 Input Voltage Ripple

The TPS54233EVM-373 input voltage ripple is shown in [Figure 8](#). The output current is the rated full load of 2 A. Voltage is measured directly across the input capacitors.

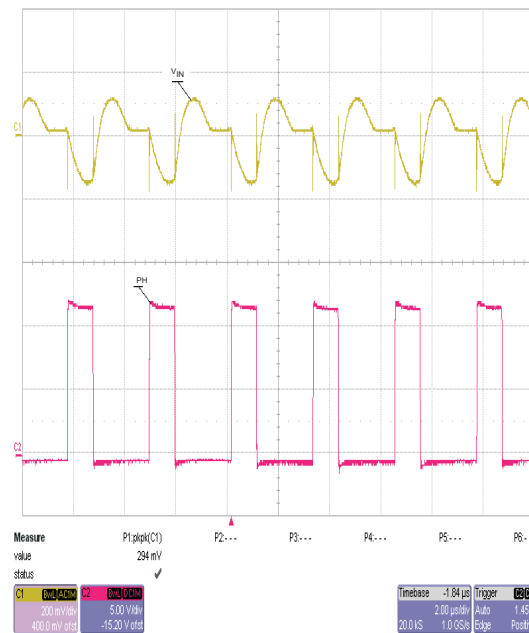


Figure 8. TPS54233EVM-373 Input Ripple

2.9 Powering Up

The start-up waveforms are shown in [Figure 9](#) and [Figure 10](#). In [Figure 9](#), the top trace shows V_{IN} , and the bottom trace shows V_{OUT} . In [Figure 10](#), the top trace shows EN (enable) whereas the bottom trace shows V_{OUT} . In [Figure 10](#), the input voltage is initially applied and the output is inhibited by using a jumper at J2 to tie EN to GND. When the jumper is removed, EN is released. When the EN voltage reaches the enable-threshold voltage of 1.25 V, the start-up sequence begins and the internal reference voltage begins to ramp up at the internally set rate toward 0.8 V and the output voltage ramps up to the externally set value of 3.3 V. The input voltage for these plots is 15 V and there is no load.

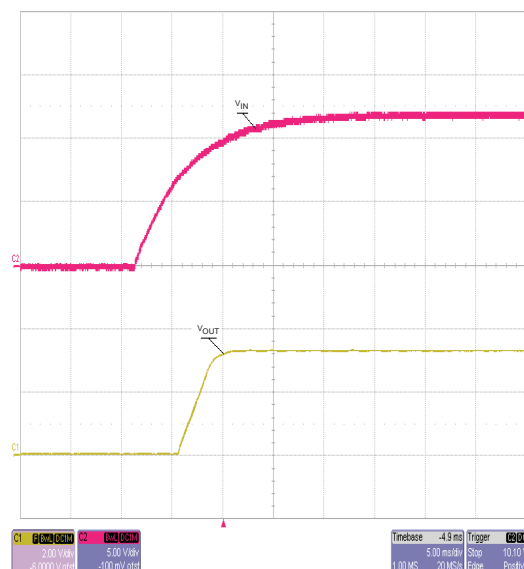


Figure 9. TPS54233EVM-373 Start-Up Relative to V_{IN}

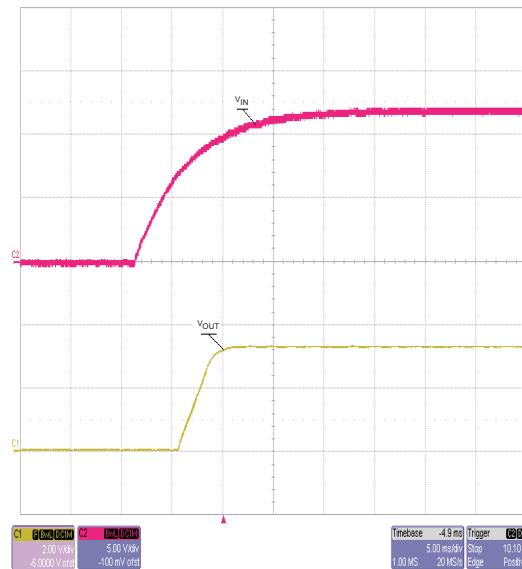


Figure 10. TPS54233EVM-373 Start-up Relative to Enable

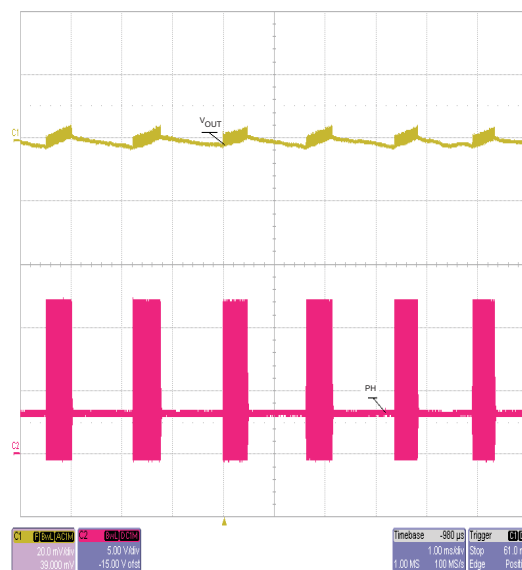


Figure 11. TPS54233EVM-373 ECO_MODE™ Operation

3 Board Layout

This section provides a description of the TPS54233EVM-373, board layout, and layer illustrations.

3.1 Layout

The board layout for the TPS54233EVM-373 is shown in [Figure 12](#) through [Figure 14](#). The topside layer of the EVM is laid out in a manner typical of a user application. The top and bottom layers are 2-oz. copper.

The top layer contains the main power traces for V_{IN} , V_{OUT} , and V_{PHASE} . Also on the top layer are connections for the remaining pins of the TPS54233 and a large area filled with ground. The bottom layer contains ground and a signal route for the BOOT capacitor. The top and bottom and internal ground traces are connected with multiple vias placed around the board including ten vias directly under the TPS54233 device to provide a thermal path from the top-side ground plane to the bottom-side ground plane.

The input decoupling capacitors (C1, C2, and C3) and bootstrap capacitor (C4) are all located as close to the IC as possible. In addition, the voltage set-point resistor divider components are also kept close to the IC. The voltage divider network ties to the output voltage at the point of regulation, the copper V_{OUT} trace past the output capacitor C9. For the TPS54233, an additional input bulk capacitor may be required, depending on the EVM connection to the input supply.

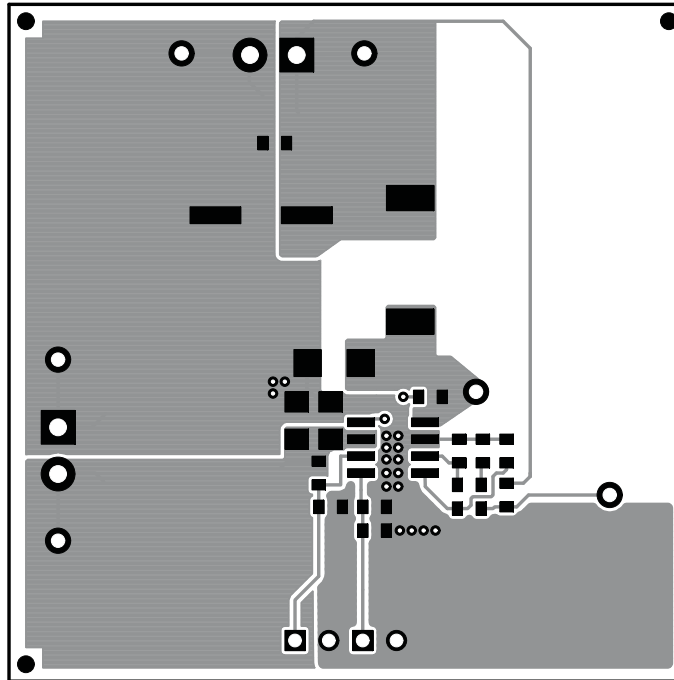


Figure 12. TPS54233EVM-373 Top-Side Layout

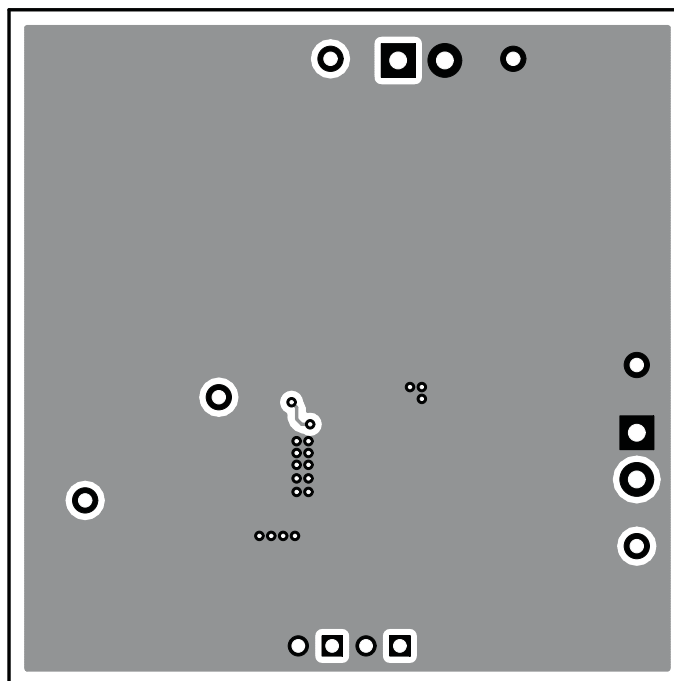


Figure 13. TPS54233EVM-373 Bottom-Side Layout

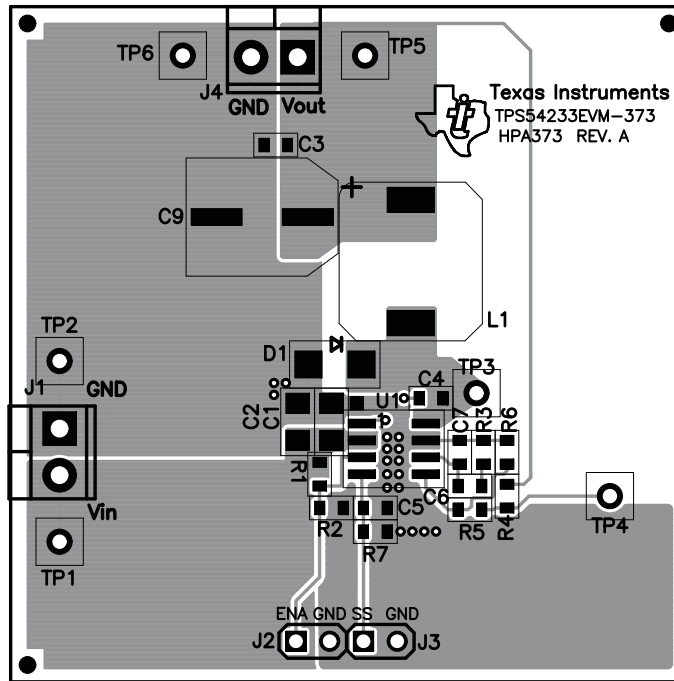


Figure 14. TPS54233EVM-373 Top-Side Assembly

3.2 Estimated Circuit Area

The estimated printed circuit board area for the components used in the design of this circuit is 0.72 in². This area does not include test points or connectors.

4 Schematic and Bill of Materials

This section presents the TPS54233EVM-373 schematic and bill of materials.

4.1 Schematic

Figure 15 is the schematic for the TPS54233EVM-373.

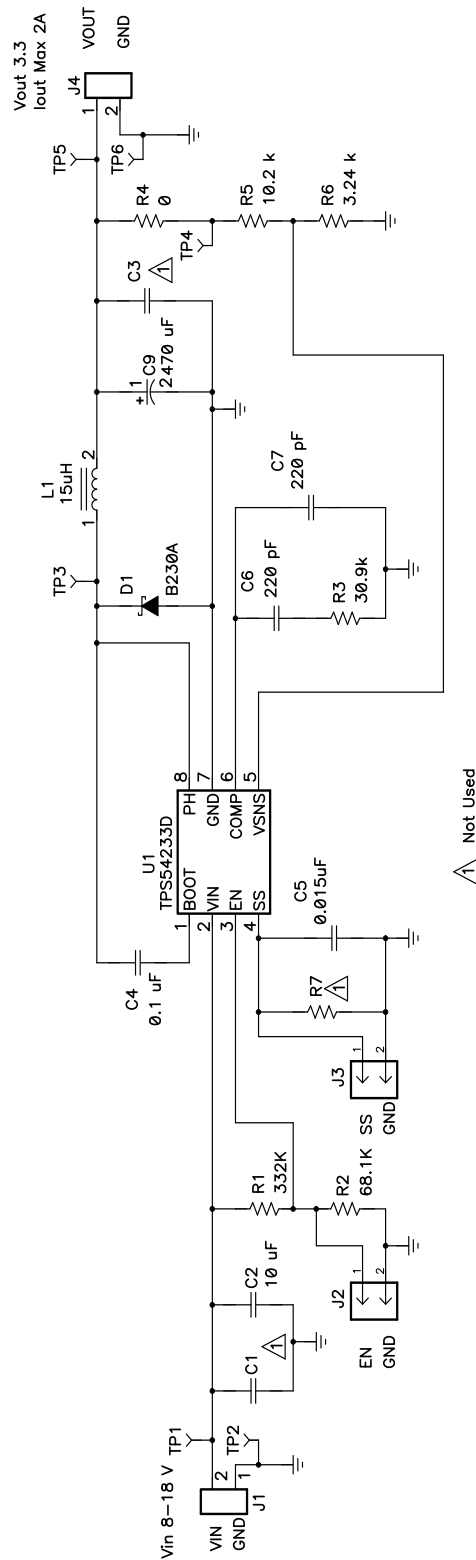


Figure 15. TPS54233EVM-373 Schematic

4.2 Bill of Materials

Table 5 presents the bill of materials for the TPS54233EVM-373.

Table 5. TPS54233EVM-373 Bill of Materials

Count	RefDes	Value	Description	Size	Part Number	MFR
0	C1	Open	Capacitor, Ceramic	1206		
1	C2	10 μ F	Capacitor, Ceramic, 25V, X5R, 10%	1206	GRM31CR61E106K A12	muRata
0	C3	Open	Capacitor, Ceramic	0603		
1	C4	0.1 μ F	Capacitor, Ceramic, 16V, X7R, 10%	0603	Std	Std
1	C5	0.015 μ F	Capacitor, Ceramic, 16V, X7R, 10%	0603	Std	Std
2	C6, C7	220 pF	Capacitor, Ceramic, 16V, X7R, 10%	0603	Std	Std
1	C8	470 μ F	Capacitor, Aluminum, 10V, 20%	0.328 x 0.328 inch	EEVFK1A471P	Panasonic
1	D1	B230A	Diode, Schottky, 2A, 40V	SMA	B240A	Diodes Inc
2	J1, J4	ED1514	Terminal Block, 2-pin, 6-A, 3.5mm	0.27 x 0.25 inch	ED1514	OST
2	J2, J3	PTC36SA AN	Header, 2-pin, 100mil spacing, (36-pin strip)	0.100 x 2	PTC36SAAN	
1	L1	15 μ H	Inductor, SMT, 3.7A, 41 m Ω	0.402 x 0.394 inch	MSS1038-273NL	Coilcraft
1	R1	332k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R2	68.1k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R3	30.9k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R4	0	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R5	10.2k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R6	3.24k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
0	R7	Open	Resistor, Chip, 1/16W, 1%	0603	Std	Std
3	TP1, TP3, TP5	5000	Test Point, Red, Thru Hole Color Keyed	0.100 x 0.100 inch	5000	Keystone
3	TP2, TP4, TP6	5001	Test Point, Black, Thru Hole Color Keyed	0.100 x 0.100 inch	5001	Keystone
1	U1	TPS5423 3D	IC, DC-DC Converter, 28V, 2A	SO-8	TPS54233D	TI
1	—		PCB	2.0" x 2.0" x 0.062"	HPA373	Any
1	—		Shunt, 100-mil, Black	0.100	929950-00	3M

Notes:

1. These assemblies are ESD sensitive, ESD precautions shall be observed
2. These assemblies must be clean and free from flux and all contaminants. Use of unclean flux is not acceptable.
3. These assemblies must comply with workmanship standards IPC-A-610 Class 2.
4. Ref designators marked with an asterisk (***) cannot be substituted. All other components can be substituted with equivalent MFG's components.

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EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range and the output current range specified in Table 1.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 55°C. The EVM is designed to operate properly with certain components above 60°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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